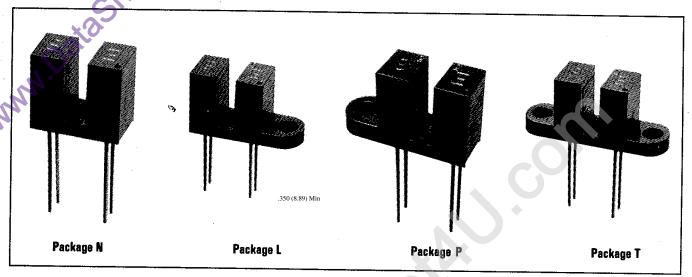


# **Slotted Optical Switches** Types OPB860, OPB870 Series



#### **Features**

- 0.125" wide gap
- · Choice of aperture
- Choice of opaque or IR transmissive shell material
- Choice of mounting configuration
- Choice of lead spacing

#### Description

The OPB860/870 series of slotted switches provides the design engineer with the flexibility of a custom device from a standard product line. Building from a standard housing with a .125' wide slot, the user can specify (1) electrical output parameters, (2) mounting tab configuration, (3) choice of lead spacing, (4) discrete shell material, and (5) aperture width.

All housings are an opaque grade of injection-molded plastic to minimize the assembly's sensitivity to ambient radiation, both visible and near-infrared. Discrete shells (exposed only on the parallel faces inside the device throat) are either IR transmissive plastic for applications where aperture contamination may occur or opaque plastic with aperture openings for maximum protection against ambient light.

### Absolute Maximum Ratings (T<sub>A</sub> = 25°C unless otherwise noted)

Storage and Operating Temperature Range	-40°	C to -	-85°C
Lead Soldering Temperature Range [1/16 inch (1.6mm) from case for	5 sec	with	enl-
dering iron]	000	2/	00(2)
Input Diode	• • • •	-7	
Forward DC Current			հ∩m∆
Peak Forward Current (1 µs pulse width, 300 pps).		• •	3 04
Reverse DC Voltage	• • • •		2.07
Power Dissipation	• • • •	100.	-10V
Output Phototransistor		1001	IIVV.
Collector-Emitter Voltage			301/
Emitter-Collector Voltage	• • • •		5.01/
Collector DC Current	• • • • •	• • • • •	0.UV
Power Dissipation.	• • • • •	100	DUITIA -
Notes:	• • • •	1001	1144, ,
	Lead Soldering Temperature Range [1/16 inch (1.6mm) from case for dering iron]	Lead Soldering Temperature Range [1/16 inch (1.6mm) from case for 5 sec dering iron]	Forward DC Current Peak Forward Current (1 µs pulse width, 300 pps).  Reverse DC Voltage. Power Dissipation 100r  Output Phototransistor  Collector-Emitter Voltage Emitter-Collector Voltage Collector DC Current Power Dissipation. 100r

(1) Derate linearly 1.67mW/°C above 25°C.

(2) RMA flux is recommended. Duration can be extended to 10 sec. max. when flow soldering.

(3) All parameters tested using pulse technique.

(4) Lead spacing of .220" or .320" is available. Leads are 0.20" sq and .425" long (min).

(5) Methyl and isopropyl alcohols are recommended as cleaning agents. Plastic housings are M.DataSheetall.com soluble in chlorinated hydrocarbons and ketones.

## Types OPB860, OPB870 Series

Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise noted)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Input Diode		* 1			×.	
VF	Forward Voltage			1.7	٧	I <sub>F</sub> = 20mA
l <sub>R</sub>	Reverse Current			100	μА	V <sub>R</sub> = 2.0V
Output Photo	otransistor					1 11 111
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage	30			V	I <sub>C</sub> = 1.0mA
V <sub>(BR)ECO</sub>	Emitter-Collector Breakdown Voltage	5.0		4.7	V	I <sub>E</sub> = 100μA
ICEO	Collector-Emitter Dark Current			100	nA	$V_{CE} = 10V$ , $I_F = 0$ , $E_{\theta} = 0$
Coupled	· ·				4.	
VCE(SAT)	Saturation Voltage: Parameter A OPB860 / OPB870 OPB865 / OPB875	*		0.4	V	I <sub>C</sub> = 400μA, I <sub>F</sub> = 20mA
	Parameter B			0.4	V	I <sub>C</sub> = 800μA, I <sub>F</sub> = 10mA
	Parameter C OPB862 / OPB872 OPB867 / OPB877			0.6	V	I <sub>C</sub> = 1800μA, I <sub>F</sub> = 20mA
IC(ON)	On-State Collector Current: Parameter A OPB860 / OPB870 OPB865 / OPB875	500		.5.	μА	V <sub>CE</sub> = 10V, I <sub>F</sub> = 20mA
	Parameter B	1000			μА	V <sub>CE</sub> = 5V, I <sub>F</sub> = 10mA
	Parameter C OPB862 / OPB872 OPB867 / OPB877	1800			μА	V <sub>CE</sub> = 0.6V, I <sub>F</sub> = 20mA

## **PART NUMBER GUIDE**

OPB 8 X X X X X

Optek Assembly	Aperture Width In Front of Sensor 5 = 0.050" 1 = 0.010"
Phototransistor Output Family	Aperture Width In Front of Emitter 5 = 0.050" 1= 0.010"*
Discrete Shell Material	Mounting Configuration
Designation	
6 - Base Mount IR Transmissive Plastic Discrete Shell PC Mountable Leads	T - Both Mounting Tabs N - No Mounting Tabs L - Single Mounting Tab Emitter Side
7 - Base Mount Opaque Plastic Discrete Shell PC Mountable Leads	 P - Single Mounting Tat Phototransistor Side
	•

**Electrical Specification Variations** 

0 - Electrical Parameter A, Lead Spacing 0.320"

1 - Electrical Parameter B, Lead Spacing 0.320"

T - Electrical Farameter B, Lead Spacing 0.320

2 - Electrical Parameter C, Lead Spacing 0.320"

5 - Electrical Parameter A, Lead Spacing 0.220"

6 - Electrical Parameter B, Lead Spacing 0.220"

7 - Electrical Parameter C, Lead Spacing 0.220"

\*Assemblies with dual 0.010" apertures are currently available with electrical parameter "A" only.

Optek reserves the right to make changes at any time in order to improve design and to supply the best product possible.

**TX-TXV Process** 

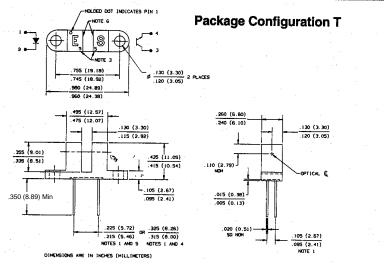
Available

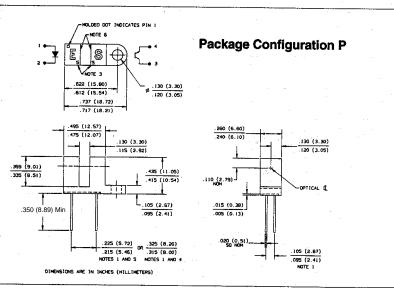
See Hi-Rel

Section

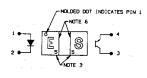
## Types OPB860, OPB870 Series

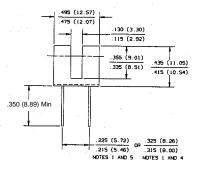


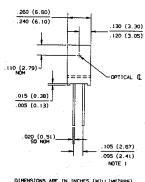




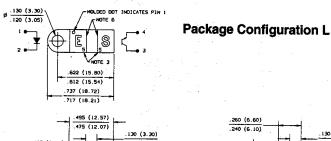
### Package Configuration N







DIMENSIONS ARE IN INCHES (MILLIMETERS)



### 240 (6.10) .105 (2.67) .115 (2.92) .435 (11.05) .335 (8.51) . 110 (2.79) J .350 (8.89) Min .005 (0.13) .225 (5.72) OR .325 (8.26) .215 (5.46) OR .315 (8.00) NOTES 1 AND 5 NOTES 1 AND 4 095 (2.41) NOTE 1 DIMENSIONS ARE IN INCHES (MILLIMETERS)

#### Notes:

- Dimension controlled at housing surace only.
   Methanol and isopropanol alcohols are recommended as cleaning agents. Housings are soluble in chlorinated. hydrocarbons and ketones. Highly activated, water soluble fluxes may attack housings in some situations.

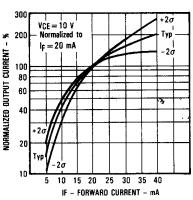
  (3) Molded number to identify aperture size. See part number
- guide. (4) OPB860, OPB861, OPB862, OPB870, OPB871, OPB872.
- (5) OPB865, OPB866, OPB867, OPB875, OPB876, OPB877. (6) Dimensions of aperture opening dependent on housing.
- See part number guide.

.120 (3.05)

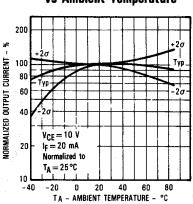
# Types OPB860, OPB870 Series

#### **Typical Performance Curves**

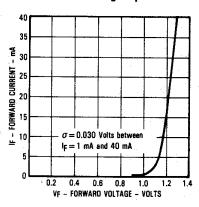
Normalized Output Current vs Forward Current



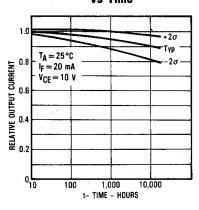
Normalized Output Current vs Ambient Temperature



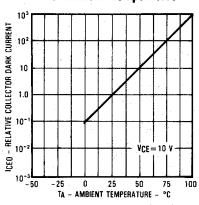
Forward Current
vs Forward Voltage Input Diode



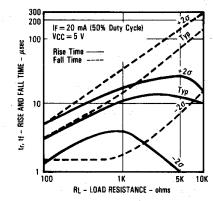
Relative Output Current vs Time



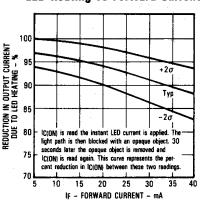
Collector Dark Current vs Ambient Temperature



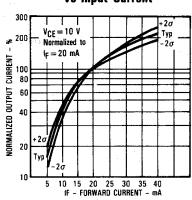
Rise and Fall Time vs Load Resistance



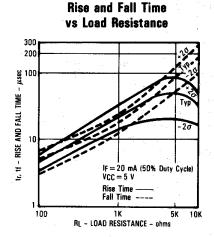
Reduction in Output Current Due to LED Heating vs Forward Current



Normalized Output Current vs Input Current



All Part Numbers Ending in "1"



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